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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Not For New Designs
Core Processor	ST7
Core Size	8-Bit
Speed	8MHz
Connectivity	SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	17
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SO
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/st7flit19f1m7tr

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DATA EEPROM (Cont'd)

5.3 MEMORY ACCESS

The Data EEPROM memory read/write access modes are controlled by the E2LAT bit of the EEP-ROM Control/Status register (EECSR). The flowchart in Figure 6 describes these different memory access modes.

Read Operation (E2LAT=0)

The EEPROM can be read as a normal ROM location when the E2LAT bit of the EECSR register is cleared. In a read cycle, the byte to be accessed is put on the data bus in less than 1 CPU clock cycle. This means that reading data from EEPROM takes the same time as reading data from EPROM, but this memory cannot be used to execute machine code.

Write Operation (E2LAT=1)

To access the write mode, the E2LAT bit has to be set by software (the E2PGM bit remains cleared). When a write access to the EEPROM area occurs,

Figure 6. Data EEPROM Programming Flowchart

the value is latched inside the 32 data latches according to its address.

When PGM bit is set by the software, all the previous bytes written in the data latches (up to 32) are programmed in the EEPROM cells. The effective high address (row) is determined by the last EEP-ROM write sequence. To avoid wrong programming, the user must take care that all the bytes written between two programming sequences have the same high address: only the five Least Significant Bits of the address can change.

At the end of the programming cycle, the PGM and LAT bits are cleared simultaneously.

Note: Care should be taken during the programming cycle. Writing to the same memory location will over-program the memory (logical AND between the two write access data result) because the data latches are only cleared at the end of the programming cycle and by the falling edge of the E2LAT bit.

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It is not possible to read the latched data. This note is ilustrated by the Figure 8.



DATA EEPROM (Cont'd)

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Figure 7. Data E²PROM Write Operation

Note: If a programming cycle is interrupted (by software or a reset action), the integrity of the data in memory is not guaranteed.

CPU REGISTERS (Cont'd) STACK POINTER (SP)

Read/Write

Reset Value: 01FFh



The Stack Pointer is a 16-bit register which is always pointing to the next free location in the stack. It is then decremented after data has been pushed onto the stack and incremented before data is popped from the stack (see Figure 10).

Since the stack is 128 bytes deep, the 9 most significant bits are forced by hardware. Following an MCU Reset, or after a Reset Stack Pointer instruction (RSP), the Stack Pointer contains its reset value (the SP6 to SP0 bits are set) which is the stack higher address.

The least significant byte of the Stack Pointer (called S) can be directly accessed by a LD instruction.

Figure 10.	Stack	Mani	pulation	Example
i igaio io	oluon	main	Salation	EXample

Note: When the lower limit is exceeded, the Stack Pointer wraps around to the stack upper limit, without indicating the stack overflow. The previously stored information is then overwritten and therefore lost. The stack also wraps in case of an underflow.

The stack is used to save the return address during a subroutine call and the CPU context during an interrupt. The user may also directly manipulate the stack by means of the PUSH and POP instructions. In the case of an interrupt, the PCL is stored at the first location pointed to by the SP. Then the other registers are stored in the next locations as shown in Figure 10.

- When an interrupt is received, the SP is decremented and the context is pushed on the stack.
- On return from interrupt, the SP is incremented and the context is popped from the stack.

A subroutine call occupies two locations and an interrupt five locations in the stack area.

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7.5 RESET SEQUENCE MANAGER (RSM)

7.5.1 Introduction

The reset sequence manager includes three RE-SET sources as shown in Figure 14:

- External RESET source pulse
- Internal LVD RESET (Low Voltage Detection)
- Internal WATCHDOG RESET

These sources act on the RESET pin and it is always kept low during the delay phase.

The RESET service routine vector is fixed at addresses FFFEh-FFFFh in the ST7 memory map.

The basic RESET sequence consists of 3 phases as shown in Figure 13:

- Active Phase depending on the RESET source
- 256 or 4096 CPU clock cycle delay (see table below)
- RESET vector fetch

The 256 or 4096 CPU clock cycle delay allows the oscillator to stabilise and ensures that recovery has taken place from the Reset state. The shorter or longer clock cycle delay is automatically selected depending on the clock source chosen by option byte:

Clock Source	CPU clock cycle delay
Internal RC Oscillator	256
External clock (connected to CLKIN pin)	256
External Crystal/Ceramic Oscillator (connected to OSC1/OSC2 pins)	4096

Figure 14. Reset Block Diagram

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The RESET vector fetch phase duration is 2 clock cycles.

If the PLL is enabled by option byte, it outputs the clock after an additional delay of t_{STARTUP} (see Figure 11).

Figure 13. RESET Sequence Phases



7.5.2 Asynchronous External RESET pin

The $\overline{\text{RESET}}$ pin is both an input and an open-drain output with integrated R_{ON} weak pull-up resistor. This pull-up has no fixed value but varies in accordance with the input voltage. It can be pulled low by external circuitry to reset the device. See Electrical Characteristic section for more details.

A RESET signal originating from an external source must have a duration of at least $t_{h(RSTL)in}$ in order to be recognized (see Figure 15). This detection is asynchronous and therefore the MCU can enter reset state even in HALT mode.



8 INTERRUPTS

The ST7 core may be interrupted by one of two different methods: maskable hardware interrupts as listed in the Interrupt Mapping Table and a nonmaskable software interrupt (TRAP). The Interrupt processing flowchart is shown in Figure 19.

The maskable interrupts must be enabled by clearing the I bit in order to be serviced. However, disabled interrupts may be latched and processed when they are enabled (see external interrupts subsection).

Note: After reset, all interrupts are disabled.

When an interrupt has to be serviced:

- Normal processing is suspended at the end of the current instruction execution.
- The PC, X, A and CC registers are saved onto the stack.
- The I bit of the CC register is set to prevent additional interrupts.
- The PC is then loaded with the interrupt vector of the interrupt to service and the first instruction of the interrupt service routine is fetched (refer to the Interrupt Mapping Table for vector addresses).

The interrupt service routine should finish with the IRET instruction which causes the contents of the saved registers to be recovered from the stack.

Note: As a consequence of the IRET instruction, the I bit will be cleared and the main program will resume.

Priority Management

By default, a servicing interrupt cannot be interrupted because the I bit is set by hardware entering in interrupt routine.

In the case when several interrupts are simultaneously pending, an hardware priority defines which one will be serviced first (see the Interrupt Mapping Table).

Interrupts and Low Power Mode

All interrupts allow the processor to leave the WAIT low power mode. Only external and specifically mentioned interrupts allow the processor to leave the HALT low power mode (refer to the "Exit from HALT" column in the Interrupt Mapping Table).

8.1 NON MASKABLE SOFTWARE INTERRUPT

This interrupt is entered when the TRAP instruction is executed regardless of the state of the I bit. It will be serviced according to the flowchart on Figure 19.

8.2 EXTERNAL INTERRUPTS

External interrupt vectors can be loaded into the PC register if the corresponding external interrupt occurred and if the I bit is cleared. These interrupts allow the processor to leave the Halt low power mode.

The external interrupt polarity is selected through the miscellaneous register or interrupt register (if available).

An external interrupt triggered on edge will be latched and the interrupt request automatically cleared upon entering the interrupt service routine.

Caution: The type of sensitivity defined in the Miscellaneous or Interrupt register (if available) applies to the ei source.

8.3 PERIPHERAL INTERRUPTS

Different peripheral interrupt flags in the status register are able to cause an interrupt when they are active if both:

- The I bit of the CC register is cleared.
- The corresponding enable bit is set in the control register.

If any of these two conditions is false, the interrupt is latched and thus remains pending.

Clearing an interrupt request is done by:

- Writing "0" to the corresponding bit in the status register or
- Access to the status register while the flag is set followed by a read or write of an associated register.

Note: the clearing sequence resets the internal latch. A pending interrupt (i.e. waiting for being enabled) will therefore be lost if the clear sequence is executed.

POWER SAVING MODES (Cont'd)

9.3 WAIT MODE

WAIT mode places the MCU in a low power consumption mode by stopping the CPU.

This power saving mode is selected by calling the 'WFI' instruction.

All peripherals remain active. During WAIT mode, the I bit of the CC register is cleared, to enable all interrupts. All other registers and memory remain unchanged. The MCU remains in WAIT mode until an interrupt or RESET occurs, whereupon the Program Counter branches to the starting address of the interrupt or Reset service routine.

The MCU will remain in WAIT mode until a Reset or an Interrupt occurs, causing it to wake up.

Refer to Figure 22.

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Figure 22. WAIT Mode Flow-chart



Note:

1. Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.

0

POWER SAVING MODES (Cont'd)

9.6.0.1 Register Description

AWUFH CONTROL/STATUS REGISTER (AWUCSR) Read/Write

Reset Value: 0000 0000 (00h)

7							0
0	0	0	0	0	AWU F	AWU M	AWU EN

Bits 7:3 = Reserved.

Bit 1= AWUF Auto Wake Up Flag

This bit is set by hardware when the AWU module generates an interrupt and cleared by software on reading AWUCSR. Writing to this bit does not change its value.

0: No AWU interrupt occurred

1: AWU interrupt occurred

Bit 1= **AWUM** Auto Wake Up Measurement

This bit enables the AWU RC oscillator and connects its output to the inputcapture of the 12-bit Auto-Reload timer. This allows the timer to be used to measure the AWU RC oscillator dispersion and then compensate this dispersion by providing the right value in the AWUPRE register.

0: Measurement disabled

1: Measurement enabled

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Bit 0 = **AWUEN** Auto Wake Up From Halt Enabled This bit enables the Auto Wake Up From Halt feature: once HALT mode is entered, the AWUFH wakes up the microcontroller after a time delay dependent on the AWU prescaler value. It is set and cleared by software.

- 0: AWUFH (Auto Wake Up From Halt) mode disabled
- 1: AWUFH (Auto Wake Up From Halt) mode enabled

AWUFH PRESCALER REGISTER (AWUPR) Read/Write

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| AWU |
|-----|-----|-----|-----|-----|-----|-----|-----|
| PR7 | PR6 | PR5 | PR4 | PR3 | PR2 | PR1 | PR0 |

Bits 7:0= **AWUPR[7:0]** Auto Wake Up Prescaler These 8 bits define the AWUPR Dividing factor (as explained below:

AWUPR[7:0]	Dividing factor
00h	Forbidden
01h	1
FEh	254
FFh	255

In AWU mode, the period that the MCU stays in Halt Mode (t_{AWU} in Figure 28 on page 43) is defined by

^tAWU =
$$64 \times AWUPR \times \frac{1}{f_{AWURC}} + t_{RCSTRT}$$

This prescaler register can be programmed to modify the time that the MCU stays in Halt mode before waking up automatically.

Note: If 00h is written to AWUPR, depending on the product, an interrupt is generated immediately after a HALT instruction, or the AWUPR remains inchanged.

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0049h	AWUPR Reset Value	AWUPR7 1	AWUPR6 1	AWUPR5 1	AWUPR4 1	AWUPR3 1	AWUPR2 1	AWUPR1 1	AWUPR0 1
004Ah	AWUCSR Reset Value	0	0	0	0	0	AWUF	AWUM	AWUEN

I/O PORTS (Cont'd)

Analog alternate function

Configure the I/O as floating input to use an ADC input. The analog multiplexer (controlled by the ADC registers) switches the analog voltage present on the selected pin to the common analog rail, connected to the ADC input.

Analog Recommendations

Do not change the voltage level or loading on any I/O while conversion is in progress. Do not have clocking pins located close to a selected analog pin.

WARNING: The analog input voltage level must be within the limits stated in the absolute maximum ratings.

10.3 I/O PORT IMPLEMENTATION

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The hardware implementation on each I/O port depends on the settings in the DDR and OR registers and specific I/O port features such as ADC input or open drain.

Switching these I/O ports from one state to another should be done in a sequence that prevents unwanted side effects. Recommended safe transitions are illustrated in Figure 31. Other transitions are potentially risky and should be avoided, since they may present unwanted side-effects such as spurious interrupt generation.

Figure 31. Interrupt I/O Port State Transitions



10.4 UNUSED I/O PINS

Unused I/O pins must be connected to fixed voltage levels. Refer to Section 13.8.

10.5 LOW POWER MODES

Mode	Description
WAIT	No effect on I/O ports. External interrupts cause the device to exit from WAIT mode.
HALT	No effect on I/O ports. External interrupts cause the device to exit from HALT mode.

10.6 INTERRUPTS

The external interrupt event generates an interrupt if the corresponding configuration is selected with DDR and OR registers and if the I bit in the CC register is cleared (RIM instruction).

Interrupt Event	Event Flag	Enable Control Bit		Exit from Halt
External interrupt on selected external event	-	DDRx ORx	Yes	Yes

LITE TIMER (Cont'd)

LITE TIMER COUNTER 2 (LTCNTR)

Read only Reset Value: 0000 0000 (00h)

7							0
CNT7	CNT7	CNT7	CNT7	CNT3	CNT2	CNT1	CNT0

Bits 7:0 = CNT[7:0] Counter 2 Reload Value. This register is read by software. The LTARR value is automatically loaded into Counter 2 (LTCN-TR) when an overflow occurs.

LITE TIMER CONTROL/STATUS REGISTER (LTCSR1)

Read / Write

Reset Value: 0x00 0000 (x0h)

7							0
ICIE	ICF	ТВ	TB1IE	TB1F	-	-	-

Bit 7 = ICIE Interrupt Enable.

This bit is set and cleared by software. 0: Input Capture (IC) interrupt disabled

1: Input Capture (IC) interrupt enabled

Bit 6 = **ICF** Input Capture Flag.

This bit is set by hardware and cleared by software by reading the LTICR register. Writing to this bit does not change the bit value.

0: No input capture

1: An input capture has occurred

Note: After an MCU reset, software must initialise the ICF bit by reading the LTICR register

Bit 5 = **TB** Timebase period selection.

This bit is set and cleared by software.

- 0: Timebase period = $t_{OSC} * 8000 (1ms @ 8 MHz)$ 1: Timebase period = $t_{OSC} * 16000 (2ms @ 8$
- MHz)

Bit 4 = **TB1IE** *Timebase Interrupt enable.* This bit is set and cleared by software. 0: Timebase (TB1) interrupt disabled

1: Timebase (TB1) interrupt enabled

Bit 3 = **TB1F** Timebase Interrupt Flag.

This bit is set by hardware and cleared by software reading the LTCSR register. Writing to this bit has no effect.

0: No counter overflow

1: A counter overflow has occurred

Bits 2:0 = Reserved

LITE TIMER INPUT CAPTURE REGISTER (LTICR)

Read only

Reset Value: 0000 0000 (00h)

7							0	
ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0	

Bits 7:0 = ICR[7:0] Input Capture Value

These bits are read by software and cleared by hardware after a reset. If the ICF bit in the LTCSR is cleared, the value of the 8-bit up-counter will be captured when a rising or falling edge occurs on the LTIC pin.



12 INSTRUCTION SET

12.1 ST7 ADDRESSING MODES

The ST7 Core features 17 different addressing modes which can be classified in 7 main groups:

Addressing Mode	Example
Inherent	nop
Immediate	ld A,#\$55
Direct	ld A,\$55
Indexed	ld A,(\$55,X)
Indirect	ld A,([\$55],X)
Relative	jrne loop
Bit operation	bset byte,#5

The ST7 Instruction set is designed to minimize the number of bytes required per instruction: To do

Table 19. ST7 Addressing Mode Overview

so, most of the addressing modes may be subdivided in two sub-modes called long and short:

- Long addressing mode is more powerful because it can use the full 64 Kbyte address space, however it uses more bytes and more CPU cycles.
- Short addressing mode is less powerful because it can generally only access page zero (0000h -00FFh range), but the instruction size is more compact, and faster. All memory to memory instructions use short addressing modes only (CLR, CPL, NEG, BSET, BRES, BTJT, BTJF, INC, DEC, RLC, RRC, SLL, SRL, SRA, SWAP)

The ST7 Assembler optimizes the use of long and short addressing modes.

	Mode		Syntax	Destination/ Source	Pointer Address (Hex.)	Pointer Size (Hex.)	Length (Bytes)
Inherent			nop				+ 0
Immediate			ld A,#\$55				+ 1
Short	Direct		ld A,\$10	00FF			+ 1
Long	Direct		ld A,\$1000	0000FFFF			+ 2
No Offset	Direct	Indexed	ld A,(X)	00FF			+ 0 (with X register) + 1 (with Y register)
Short	Direct	Indexed	ld A,(\$10,X)	001FE			+ 1
Long	Direct	Indexed	ld A,(\$1000,X)	0000FFFF			+ 2
Short	Indirect		ld A,[\$10]	00FF	00FF	byte	+ 2
Long	Indirect		ld A,[\$10.w]	0000FFFF	00FF	word	+ 2
Short	Indirect	Indexed	ld A,([\$10],X)	001FE	00FF	byte	+ 2
Long	Indirect	Indexed	ld A,([\$10.w],X)	0000FFFF	00FF	word	+ 2
Relative	Direct		jrne loop	PC-128/PC+127 ¹⁾			+ 1
Relative	Indirect		jrne [\$10]	PC-128/PC+127 ¹⁾	00FF	byte	+ 2
Bit	Direct		bset \$10,#7	00FF			+ 1
Bit	Indirect		bset [\$10],#7	00FF	00FF	byte	+ 2
Bit	Direct	Relative	btjt \$10,#7,skip	00FF			+ 2
Bit	Indirect	Relative	btjt [\$10],#7,skip	00FF	00FF	byte	+ 3

Note 1. At the time the instruction is executed, the Program Counter (PC) points to the instruction following JRxx.

INSTRUCTION GROUPS (Cont'd)

Mnemo	Description	Function/Example	Dst	Src	н	I	Ν	Z	С
ADC	Add with Carry	A = A + M + C	А	М	Н		Ν	Z	С
ADD	Addition	A = A + M	А	М	Н		Ν	Z	С
AND	Logical And	A = A . M	А	М			Ν	Z	
BCP	Bit compare A, Memory	tst (A . M)	А	М			Ν	Z	
BRES	Bit Reset	bres Byte, #3	М						
BSET	Bit Set	bset Byte, #3	М						
BTJF	Jump if bit is false (0)	btjf Byte, #3, Jmp1	М						С
BTJT	Jump if bit is true (1)	btjt Byte, #3, Jmp1	М						С
CALL	Call subroutine								
CALLR	Call subroutine relative								
CLR	Clear		reg, M				0	1	
СР	Arithmetic Compare	tst(Reg - M)	reg	М			Ν	Z	С
CPL	One Complement	A = FFH-A	reg, M				Ν	Z	1
DEC	Decrement	dec Y	reg, M				Ν	Z	
HALT	Halt					0			
IRET	Interrupt routine return	Pop CC, A, X, PC			Н	Ι	Ν	Z	С
INC	Increment	inc X	reg, M				Ν	Z	
JP	Absolute Jump	jp [TBL.w]							
JRA	Jump relative always								
JRT	Jump relative								
JRF	Never jump	jrf *							
JRIH	Jump if ext. interrupt = 1								
JRIL	Jump if ext. interrupt = 0								
JRH	Jump if H = 1	H = 1 ?							
JRNH	Jump if H = 0	H = 0 ?							
JRM	Jump if I = 1	I = 1 ?							
JRNM	Jump if I = 0	I = 0 ?							
JRMI	Jump if N = 1 (minus)	N = 1 ?							
JRPL	Jump if N = 0 (plus)	N = 0 ?							
JREQ	Jump if Z = 1 (equal)	Z = 1 ?							
JRNE	Jump if Z = 0 (not equal)	Z = 0 ?							
JRC	Jump if C = 1	C = 1 ?							
JRNC	Jump if C = 0	C = 0 ?							
JRULT	Jump if C = 1	Unsigned <							
JRUGE	Jump if C = 0	Jmp if unsigned >=							
JRUGT	Jump if $(C + Z = 0)$	Unsigned >							

13.3.2 Operating Conditions with Low Voltage Detector (LVD)

 $T_A = -40$ to 85°C, unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IT+(LVD)}	Reset release threshold (V _{DD} rise)	High Threshold Med. Threshold Low Threshold	4.00 ¹⁾ 3.40 ¹⁾ 2.65 ¹⁾	4.25 3.60 2.90	4.50 3.80 3.15	V
V _{IT-(LVD)}	Reset generation threshold (V _{DD} fall)	High Threshold Med. Threshold Low Threshold	3.80 3.20 2.40	4.05 3.40 2.70	4.30 ¹⁾ 3.65 ¹⁾ 2.90 ¹⁾	v
V _{hys}	LVD voltage threshold hysteresis	V _{IT+(LVD)} -V _{IT-(LVD)}		200		mV
Vt _{POR}	V _{DD} rise time rate ²⁾		20		20000	μs/V
t _{g(VDD)}	Filtered glitch delay on V_{DD}	Not detected by the LVD			150	ns
I _{DD(LVD})	LVD/AVD current consumption			220		μA

Note:

1. Not tested in production.

2. Not tested in production. The V_{DD} rise time rate condition is needed to insure a correct device power-on and LVD reset. When the V_{DD} slope is outside these values, the LVD may not ensure a proper reset of the MCU.

13.3.3 Auxiliary Voltage Detector (AVD) Thresholds

 $T_A = -40$ to 85°C, unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IT+(AVD)}	1=>0 AVDF flag toggle threshold (V _{DD} rise)	High Threshold Med. Threshold Low Threshold	4.40 ¹⁾ 3.90 ¹⁾ 3.20 ¹⁾	4.70 4.10 3.40	5.00 4.30 3.60	V
V _{IT-(AVD)}	0=>1 AVDF flag toggle threshold (V _{DD} fall)	High Threshold Med. Threshold Low Threshold	4.30 3.70 2.90	4.60 3.90 3.20	4.90 ¹⁾ 4.10 ¹⁾ 3.40 ¹⁾	v
V _{hys}	AVD voltage threshold hysteresis	V _{IT+(AVD)} -V _{IT-(AVD)}		150		mV
$\Delta V_{\text{IT-}}$	Voltage drop between AVD flag set and LVD reset activation	V _{DD} fall		0.45		V

Note:

1. Not tested in production.

13.3.4 Internal RC Oscillator and PLL

The ST7 internal clock can be supplied by an internal RC oscillator and PLL (selectable by option byte).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD(RC)}	Internal RC Oscillator operating voltage		2.4		5.5	
V _{DD(x4PLL)}	x4 PLL operating voltage		2.4		3.3	V
V _{DD(x8PLL)}	x8 PLL operating voltage		3.3		5.5	
t _{STARTUP}	PLL Startup time			60		PLL input clock (f _{PLL}) cycles

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OPERATING CONDITIONS (Cont'd)



Figure 57. PLLx4 Output vs CLKIN frequency



Figure 58. PLLx8 Output vs CLKIN frequency



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Note: $f_{OSC} = f_{CLKIN}/2*PLL8$

Note: f_{OSC} = f_{CLKIN}/2*PLL4

13.3.4.3 32MHz PLL

 $T_A = -40$ to 85°C, unless otherwise specified

Symbol	Parameter	Min	Тур	Max	Unit
V _{DD}	Voltage ¹⁾	4.5	5	5.5	V
f _{PLL32}	Frequency ¹⁾		32		MHz
f _{INPUT}	Input Frequency	7	8	9	MHz

Note 1: 32 MHz is guaranteed within this voltage range.

13.5 CLOCK AND TIMING CHARACTERISTICS

Subject to general operating conditions for V_{DD}, f_{OSC}, and T_A.

13.5.1 General Timings

Symbol	Parameter 1)	Conditions	Min	Typ ²⁾	Max	Unit
t _{c(INST)}	Instruction cycle time		2	3	12	t _{CPU}
		f _{CPU} =8MHz	250	375	1500	ns
+	Interrupt reaction time ³⁾	f _QMLI¬	10		22	t _{CPU}
	$t_{v(IT)} = \Delta t_{c(INST)} + 10$	f _{CPU} =8MHz	1.25		2.75	μs

Notes:

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1. Guaranteed by Design. Not tested in production.

2. Data based on typical application software.

3. Time measured between interrupt event and interrupt vector fetch. $Dt_{c(INST)}$ is the number of t_{CPU} cycles needed to finish the current instruction execution.

13.5.2 Auto Wakeup from Halt Oscillator (AWU)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{AWU}	AWU Oscillator Frequency		50	125	250	kHz
t _{RCSRT}	AWU Oscillator startup time				50	μs

13.8 I/O PORT PIN CHARACTERISTICS

13.8.1 General Characteristics

Subject to general operating conditions for V_{DD}, f_{OSC}, and T_A unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{IL}	Input low level voltage			V _{SS} - 0.3		0.3xV _{DD}	V
V _{IH}	Input high level voltage			0.7xV _{DD}		V _{DD} + 0.3	v
V _{hys}	Schmitt trigger voltage				400		mV
۱ _L	Input leakage current	V _{SS} ≤V _{IN} ≤	≤V _{DD}			±1	A
ا _S	Static current consumption ²⁾	Floating input mode				200	μA
R _{PU}	Weak pull-up equivalent resistor ³⁾	V _{IN} =V _{SS}	V _{DD} =5V	50	120	250	kΩ
			V _{DD} =3V		160		
CIO	I/O pin capacitance				5		pF
t _{f(IO)out}	Output high to low level fall time ¹⁾	C _L =50pF			25		20
t _{r(IO)out}	Output low to high level rise time ¹⁾	Between	10% and 90%		25		ns
t _{w(IT)in}	External interrupt pulse time 4)			1			t _{CPU}

Notes:

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1. Data based on characterization results, not tested in production.

2. Configuration not recommended, all unused pins must be kept at a fixed voltage: using the output mode of the I/O for example or an external pull-up or pull-down resistor (see Figure 65). Data based on design simulation and/or technology characteristics, not tested in production.

3. The RPU pull-up equivalent resistor is based on a resistive transistor (corresponding IPU current characteristics described in Figure 66).

4. To generate an external interrupt, a minimum pulse width has to be applied on an I/O port pin configured as an external interrupt source.

Figure 65. Two typical Applications with unused I/O Pin



Figure 66. Typical I_{PU} vs. V_{DD} with V_{IN}=V_{SS}



I/O PORT PIN CHARACTERISTICS (Cont'd)

Figure 79. Typical V_{OL} vs. V_{DD} (standard I/Os)



Figure 80. Typical V_{OL} vs. V_{DD} (high-sink I/Os)



Figure 81. Typical V_{DD} - V_{OH} vs. V_{DD}



COMMUNICATION INTERFACE CHARACTERISTICS (Cont'd)



Figure 85. SPI Slave Timing Diagram with CPHA=1¹⁾

Figure 86. SPI Master Timing Diagram ¹⁾



Notes:

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1. Measurement points are done at CMOS levels: $0.3 x V_{DD}$ and $0.7 x V_{DD}.$

2. When no communication is on-going the data output line of the SPI (MOSI in master mode, MISO in slave mode) has its alternate function capability released. In this case, the pin status depends of the I/O port configuration.

Table 26. ST7 Application Notes

DESCRIPTION				
PROGRAMMING ST7 FLASH MICROCONTROLLERS IN REMOTE ISP MODE (IN-SITU PRO- GRAMMING)				
USING THE ST72521 EMULATOR TO DEBUG A ST72324 TARGET APPLICATION				
EMULATED DATA EEPROM WITH XFLASH MEMORY				
PORTING AN ST7 PANTA PROJECT TO CODEWARRIOR IDE				
DEVELOPING A USB SMARTCARD READER WITH ST7SCR				
ON-BOARD PROGRAMMING METHODS FOR XFLASH AND HDFLASH ST7 MCUS				
IN-APPLICATION PROGRAMMING (IAP) DRIVERS FOR ST7 HDFLASH OR XFLASH MCUS				
DEVICE FIRMWARE UPGRADE (DFU) IMPLEMENTATION FOR ST7 USB APPLICATIONS				
SOFTWARE IMPLEMENTATION FOR ST7DALI-EVAL				
USING THE ST7 USB DEVICE FIRMWARE UPGRADE DEVELOPMENT KIT (DFU-DK)				
ST7 CUSTOMER ROM CODE RELEASE INFORMATION				
DATA LOGGING PROGRAM FOR TESTING ST7 APPLICATIONS VIA ICC				
FIELD UPDATES FOR FLASH BASED ST7 APPLICATIONS USING A PC COMM PORT				
HARDWARE IMPLEMENTATION FOR ST7DALI-EVAL				
ST7MC THREE-PHASE AC INDUCTION MOTOR CONTROL SOFTWARE LIBRARY				
SYSTEM OPTIMIZATION				
SOFTWARE TECHNIQUES FOR COMPENSATING ST7 ADC ERRORS				
IMPLEMENTATION OF SIGMA-DELTA ADC WITH ST7FLITE05/09				

17 REVISION HISTORY

Table 27. Revision History

Date	Revision	Description of Changes		
July 03	1.3	Changed section 3 on page 9 and Figure 3 Added note on RC oscillator in section 7 on page 23 (main features) and changed section 7.1 on page 23: removed reference to ST7LITE10 in RCCR table Changed Figure 12 on page 25 (CLKIN/2, OSC/2) Added note in section 7.4 on page 26 (external clock source paragraph) Changed section 13.3.1 on page 93: f _{CLKIN} instead of f _{OSC} Added note in the description of OSC option bit and in Table 23 on page 122		
Dec-2004	2.0	Revision number incremented from 1.3 to 2.0 due to Internal Document Management System change Modified Caution to pin n°12 (SO20) or pin n°7 (DIP20) and added caution to PB0 and PB1 in Table 1 on page 7 Changed Caution in section 4.4 on page 13 Removed "optional" referring to VDD in Figure 4 on page 13 In section 4.5.1 on page 14: Changed 1st sentence and Clarification of Flash read-out pro- tection Replaced CRSR register by SICSR register in section 7.6.3 on page 32 Added note in section 7.6.1 on page 29 Reset delay in section 11.1.3 on page 51 changed to 30µs MOD00 replaced by 0Ex in Figure 36 on page 57 Added Note 2 related to Exit from Active Halt, section 11.2.5 on page 59 Changed "Output Compare Mode" on page 57 and note 1 in section 11.2.6 on page 60 Replaced ICAP1 pin by UTC Pin in section 11.3.3 on page 66 Changed section 11.4.2 on page 70 Changed section 11.4.2 on page 73 Changed "An interrupt is generated if SPIE = 1 in the SPICSR register" to "An interrupt is generated if SPIE = 1 in the SPICR register" in description of OVR and MODF bits in section 11.4.8 on page 78 Added lilegal opcode detection to page 1, section 7.6 on page 29, section 12 on page 85 Removed references to "4.0°C to +125°C" temperature range in section 13.0 n page 91 Attered note 1 for section 13.2.2 on page 92 (PB0 and PB1) Changed section 13.2.1 on page 93 f _{PLL} value of 1MHz quoted as Typical instead of a Minimum in section 13.3.4.1 on page 95 In section 13.4.1 on page 93 f _{PLL} value of 1.1.7 on page 102 Changed section 13.7 on page 103 Added data for Fcpu @ 1MHz into Section 13.4.1 Supply Current table. Updated Figure 65 on page 102 Changed section 13.7 on page 103 Added value figure 65 on page 102 Changed section 13.7 on page 103 Added duat for Fcpu @ 1MHz into Section 13.8.1 on page 105 and in section 13.9.1 on page 110 Modified "Asynchronous RESET Pin" on page 110 (Figure 82 and Figure 83) Updated f _{SCK} in section 13.10.1 on page 112 to f _{CPU} /4 and f _{CPU} /2 Updated f _{SCK} in section		